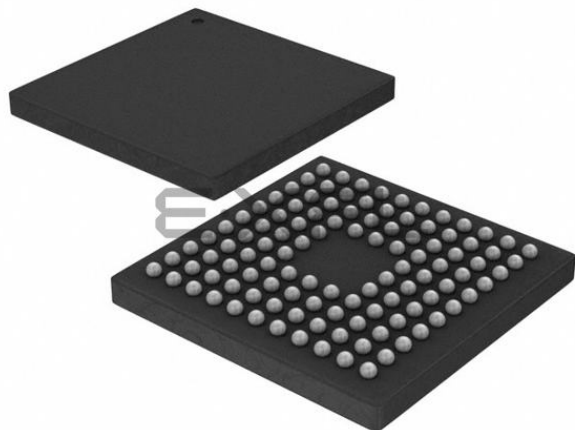




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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	ARM® Cortex®-M4
Core Size	32-Bit Single-Core
Speed	72MHz
Connectivity	CANbus, EBI/EMI, I ² C, IrDA, LINbus, SmartCard, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, LCD, POR, PWM, WDT
Number of I/O	90
Program Memory Size	2MB (2M x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.8V
Data Converters	A/D 16x12b SAR; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	112-LFBGA
Supplier Device Package	112-BGA (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/efm32gg11b320f2048gl112-ar

1. Feature List

The EFM32GG11 highlighted features are listed below.

- **ARM Cortex-M4 CPU platform**
 - High performance 32-bit processor @ up to 72 MHz
 - DSP instruction support and Floating Point Unit
 - Memory Protection Unit
 - Wake-up Interrupt Controller
- **Flexible Energy Management System**
 - 80 μ A/MHz in Active Mode (EM0)
 - 2.1 μ A EM2 Deep Sleep current (16 kB RAM retention and RTCC running from LFRCO)
- **Integrated DC-DC buck converter**
- **Up to 2048 kB flash program memory**
 - Dual-bank with read-while-write support
- **Up to 512 kB RAM data memory**
 - 256 kB with ECC (SEC-DED)
- **Octal/Quad-SPI Flash Memory Interface**
 - Supports 3 V and 1.8 V memories
 - 1/2/4/8-bit data bus
 - Quad-SPI Execute In Place (XIP)
- **Communication Interfaces**
 - Low-energy Universal Serial Bus (USB) with Device and Host support
 - Fully USB 2.0 compliant
 - On-chip PHY and embedded 5V to 3.3V regulator
 - Crystal-free Device mode operation
 - Patent-pending Low-Energy Mode (LEM)
 - SD/MMC/SDIO Host Controller
 - SD v3.01, SDIO v3.0 and MMC v4.51
 - 1/4/8-bit bus width
 - 10/100 Ethernet MAC with MII/RMII interface
 - IEEE1588-2008 precision time stamping
 - Energy Efficient Ethernet (802.3az)
 - Up to 2 $\times$ CAN Bus Controller
 - Version 2.0A and 2.0B up to 1 Mbps
 - 6 $\times$ Universal Synchronous/Asynchronous Receiver/ Transmitter
 - UART/SPI/SmartCard (ISO 7816)/IrDA/I2S/LIN
 - Triple buffered full/half-duplex operation with flow control
 - Ultra high speed (36 MHz) operation on one instance
 - 2 $\times$ Universal Asynchronous Receiver/ Transmitter
 - 2 $\times$ Low Energy UART
 - Autonomous operation with DMA in Deep Sleep Mode
 - 3 $\times$ I²C Interface with SMBus support
 - Address recognition in EM3 Stop Mode
- **Up to 144 General Purpose I/O Pins**
 - Configurable push-pull, open-drain, pull-up/down, input filter, drive strength
 - Configurable peripheral I/O locations
 - 5 V tolerance on select pins
 - Asynchronous external interrupts
 - Output state retention and wake-up from Shutoff Mode
- **Up to 24 Channel DMA Controller**
- **Up to 24 Channel Peripheral Reflex System (PRS) for autonomous inter-peripheral signaling**
- **External Bus Interface for up to 4x256 MB of external memory mapped space**
 - TFT Controller with Direct Drive
 - Per-pixel alpha-blending engine
- **Hardware Cryptography**
 - AES 128/256-bit keys
 - ECC B/K163, B/K233, P192, P224, P256
 - SHA-1 and SHA-2 (SHA-224 and SHA-256)
 - True Random Number Generator (TRNG)
- **Hardware CRC engine**
 - Single-cycle computation with 8/16/32-bit data and 16-bit (programmable)/32-bit (fixed) polynomial
- **Security Management Unit (SMU)**
 - Fine-grained access control for on-chip peripherals
- **Integrated Low-energy LCD Controller with up to 8 $\times$ 36 segments**
 - Voltage boost, contrast and autonomous animation
 - Patented low-energy LCD driver
- **Backup Power Domain**
 - RTCC and retention registers in a separate power domain, available down to energy mode EM4H
 - Operation from backup battery when main power absent/insufficient
- **Ultra Low-Power Precision Analog Peripherals**
 - 2 $\times$ 12-bit 1 Msamples/s Analog to Digital Converter (ADC)
 - On-chip temperature sensor
 - 2 $\times$ 12-bit 500 ksamples/s Digital to Analog Converter (VDAC)
 - Digital to Analog Current Converter (IDAC)
 - Up to 4 $\times$ Analog Comparator (ACMP)
 - Up to 4 $\times$ Operational Amplifier (OPAMP)
 - Robust current-based capacitive sensing with up to 64 inputs and wake-on-touch (CSEN)
 - Up to 108 GPIO pins are analog-capable. Flexible analog peripheral-to-pin routing via Analog Port (APORT)
 - Supply Voltage Monitor

4.1.6 Backup Supply Domain

Table 4.6. Backup Supply Domain

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Backup supply voltage range	V _{BU_VIN}		1.8	—	3.8	V
PWRRES resistor	R _{PWRRES}	EMU_BUCTRL_PWRRES = RES0	3400	3900	4400	Ω
		EMU_BUCTRL_PWRRES = RES1	1450	1800	2150	Ω
		EMU_BUCTRL_PWRRES = RES2	1000	1350	1700	Ω
		EMU_BUCTRL_PWRRES = RES3	525	815	1100	Ω
Output impedance between BU_VIN and BU_VOUT ²	R _{BU_VOUT}	EMU_BUCTRL_VOUTRES = STRONG	35	110	185	Ω
		EMU_BUCTRL_VOUTRES = MED	475	775	1075	Ω
		EMU_BUCTRL_VOUTRES = WEAK	5600	6500	7400	Ω
Supply current	I _{BU_VIN}	BU_VIN not powering backup do- main	—	11	TBD	nA
		BU_VIN powering backup do- main ¹	—	550	TBD	nA

Note:
1. Additional current required by backup circuitry when backup is active. Includes supply current of backup switches and backup regulator. Does not include supply current required for backed-up circuitry.
2. BU_VOUT and BU_STAT signals are not available in all package configurations. Check the device pinout for availability.

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Signal to noise and distortion ratio (1 kHz sine wave), Noise band limited to 250 kHz	SNDR _{DAC}	500 ksps, single-ended, internal 1.25V reference	—	60.4	—	dB
		500 ksps, single-ended, internal 2.5V reference	—	61.6	—	dB
		500 ksps, single-ended, 3.3V VDD reference	—	64.0	—	dB
		500 ksps, differential, internal 1.25V reference	—	63.3	—	dB
		500 ksps, differential, internal 2.5V reference	—	64.4	—	dB
		500 ksps, differential, 3.3V VDD reference	—	65.8	—	dB
Signal to noise and distortion ratio (1 kHz sine wave), Noise band limited to 22 kHz	SNDR _{DAC_BAND}	500 ksps, single-ended, internal 1.25V reference	—	65.3	—	dB
		500 ksps, single-ended, internal 2.5V reference	—	66.7	—	dB
		500 ksps, differential, 3.3V VDD reference	—	68.5	—	dB
		500 ksps, differential, internal 1.25V reference	—	67.8	—	dB
		500 ksps, differential, internal 2.5V reference	—	69.0	—	dB
		500 ksps, single-ended, 3.3V VDD reference	—	70.0	—	dB
Total harmonic distortion	THD		—	70.2	—	dB
Differential non-linearity ³	DNL _{DAC}		TBD	—	TBD	LSB
Integral non-linearity	INL _{DAC}		TBD	—	TBD	LSB
Offset error ⁵	V _{OFFSET}	T = 25 °C	TBD	—	TBD	mV
		Across operating temperature range	TBD	—	TBD	mV
Gain error ⁵	V _{GAIN}	T = 25 °C, Low-noise internal reference (REFSEL = 1V25LN or 2V5LN)	TBD	—	TBD	%
		Across operating temperature range, Low-noise internal reference (REFSEL = 1V25LN or 2V5LN)	TBD	—	TBD	%
External load capacitance, OUTSCALE=0	C _{LOAD}		—	—	75	pF

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Note: 1. Supply current specifications are for VDAC circuitry operating with static output only and do not include current required to drive the load. 2. In differential mode, the output is defined as the difference between two single-ended outputs. Absolute voltage on each output is limited to the single-ended range. 3. Entire range is monotonic and has no missing codes. 4. Current from HUPERCLK is dependent on HUPERCLK frequency. This current contributes to the total supply current used when the clock to the DAC module is enabled in the CMU. 5. Gain is calculated by measuring the slope from 10% to 90% of full scale. Offset is calculated by comparing actual VDAC output at 10% of full scale to ideal VDAC output at 10% of full scale with the measured gain. 6. PSRR calculated as $20 * \log_{10}(\Delta V_{DD} / \Delta V_{OUT})$, VDAC output at 90% of full scale						

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Open-loop gain	G _{OL}	DRIVESTRENGTH = 3	—	135	—	dB
		DRIVESTRENGTH = 2	—	137	—	dB
		DRIVESTRENGTH = 1	—	121	—	dB
		DRIVESTRENGTH = 0	—	109	—	dB
Loop unit-gain frequency ⁷	UGF	DRIVESTRENGTH = 3, Buffer connection	—	3.38	—	MHz
		DRIVESTRENGTH = 2, Buffer connection	—	0.9	—	MHz
		DRIVESTRENGTH = 1, Buffer connection	—	132	—	kHz
		DRIVESTRENGTH = 0, Buffer connection	—	34	—	kHz
		DRIVESTRENGTH = 3, 3x Gain connection	—	2.57	—	MHz
		DRIVESTRENGTH = 2, 3x Gain connection	—	0.71	—	MHz
		DRIVESTRENGTH = 1, 3x Gain connection	—	113	—	kHz
		DRIVESTRENGTH = 0, 3x Gain connection	—	28	—	kHz
Phase margin	PM	DRIVESTRENGTH = 3, Buffer connection	—	67	—	°
		DRIVESTRENGTH = 2, Buffer connection	—	69	—	°
		DRIVESTRENGTH = 1, Buffer connection	—	63	—	°
		DRIVESTRENGTH = 0, Buffer connection	—	68	—	°
Output voltage noise	N _{OUT}	DRIVESTRENGTH = 3, Buffer connection, 10 Hz - 10 MHz	—	146	—	μVrms
		DRIVESTRENGTH = 2, Buffer connection, 10 Hz - 10 MHz	—	163	—	μVrms
		DRIVESTRENGTH = 1, Buffer connection, 10 Hz - 1 MHz	—	170	—	μVrms
		DRIVESTRENGTH = 0, Buffer connection, 10 Hz - 1 MHz	—	176	—	μVrms
		DRIVESTRENGTH = 3, 3x Gain connection, 10 Hz - 10 MHz	—	313	—	μVrms
		DRIVESTRENGTH = 2, 3x Gain connection, 10 Hz - 10 MHz	—	271	—	μVrms
		DRIVESTRENGTH = 1, 3x Gain connection, 10 Hz - 1 MHz	—	247	—	μVrms
		DRIVESTRENGTH = 0, 3x Gain connection, 10 Hz - 1 MHz	—	245	—	μVrms

4.1.21 Pulse Counter (PCNT)

Table 4.29. Pulse Counter (PCNT)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Input frequency	F_{IN}	Asynchronous Single and Quadrature Modes	—	—	20	MHz
		Sampled Modes with Debounce filter set to 0.	—	—	8	kHz

4.1.22 Analog Port (APORT)

Table 4.30. Analog Port (APORT)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Supply current ^{2 1}	I_{APORT}	Operation in EM0/EM1	—	7	—	μA
		Operation in EM2/EM3	—	915	—	nA

Note:

- Specified current is for continuous APORT operation. In applications where the APORT is not requested continuously (e.g. periodic ACMP requests from LESENSE in EM2), the average current requirements can be estimated by multiplying the duty cycle of the requests by the specified continuous current number.
- Supply current increase that occurs when an analog peripheral requests access to APORT. This current is not included in reported module currents. Additional peripherals requesting access to APORT do not incur further current.

EBI TFT Output Timing

All numbers are based on route locations 0,1,2 only (with all EBI alternate functions using the same location at the same time). Timing is specified at 10% and 90% of IOVDD, 25 pF external loading, and slew rate for all GPIO set to 6.

Table 4.39. EBI TFT Output Timing

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Output hold time, EBI_DCLK to EBI_AD invalid	t_{OH_DCLK}	IOVDD $\geq$ 1.62 V	-23 + (TFTHOLD * t_{HFCOR-} ECLK)	—	—	ns
		IOVDD $\geq$ 3.0 V	-12 + (TFTHOLD * t_{HFCOR-} ECLK)	—	—	ns
Output setup time, EBI_AD valid to EBI_DCLK	t_{OSU_DCLK}	IOVDD $\geq$ 1.62 V	-11 + (TFTSET- UP * t_{HFCOR-} ECLK)	—	—	ns
		IOVDD $\geq$ 3.0 V	-9 + (TFTSET- UP * t_{HFCOR-} ECLK)	—	—	ns

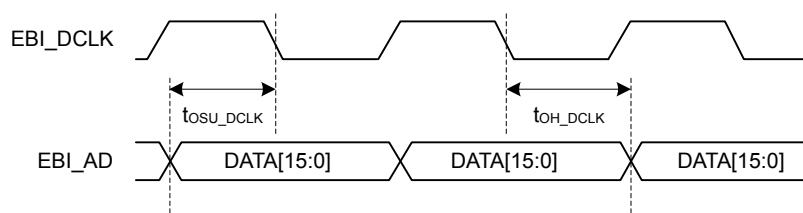


Figure 4.6. EBI TFT Output Timing

SDIO MMC SDR Mode Timing at 3.0 V

Timing is specified for route location 0 at 3.0 V IOVDD with voltage scaling disabled. Slew rate for SD_CLK set to 7, all other GPIO set to 6, DRIVESTRENGTH = STRONG for all pins. SDIO_CTRL_TXDLYMUXSEL = 1. Loading between 5 and 10 pF on all pins or between 10 and 20 pF on all pins.

Table 4.51. SDIO MMC SDR Mode Timing (Location 0, 3V I/O)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Clock frequency during data transfer	F_{SD_CLK}	Using HFRCO, AUXHFRCO, or USHFRCO	—	—	48	MHz
		Using HFXO	—	—	TBD	MHz
Clock low time	t_{WL}	Using HFRCO, AUXHFRCO, or USHFRCO	9.4	—	—	ns
		Using HFXO	TBD	—	—	ns
Clock high time	t_{WH}	Using HFRCO, AUXHFRCO, or USHFRCO	9.4	—	—	ns
		Using HFXO	TBD	—	—	ns
Clock rise time	t_R		1.96	3.87	—	ns
Clock fall time	t_F		1.67	3.31	—	ns
Input setup time, CMD, DAT[0:7] valid to SD_CLK	t_{ISU}		5.3	—	—	ns
Input hold time, SD_CLK to CMD, DAT[0:7] change	t_{IH}		2.5	—	—	ns
Output delay time, SD_CLK to CMD, DAT[0:7] valid	t_{ODLY}		0	—	16	ns
Output hold time, SD_CLK to CMD, DAT[0:7] change	t_{OH}		3	—	—	ns

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PF2	78	GPIO	VBUS	79	USB VBUS signal and auxiliary input to 5 V regulator.
PF12	80	GPIO	PF5	81	GPIO
PF6	84	GPIO	PF7	85	GPIO
PF8	86	GPIO	PF9	87	GPIO
PD9	88	GPIO	PD10	89	GPIO
PD11	90	GPIO	PD12	91	GPIO
PE8	92	GPIO	PE9	93	GPIO
PE10	94	GPIO	PE11	95	GPIO
PE12	96	GPIO	PE13	97	GPIO
PE14	98	GPIO	PE15	99	GPIO
PA15	100	GPIO			

Note:

1. GPIO with 5V tolerance are indicated by (5V).

5.16 EFM32GG11B8xx in QFN64 Device Pinout

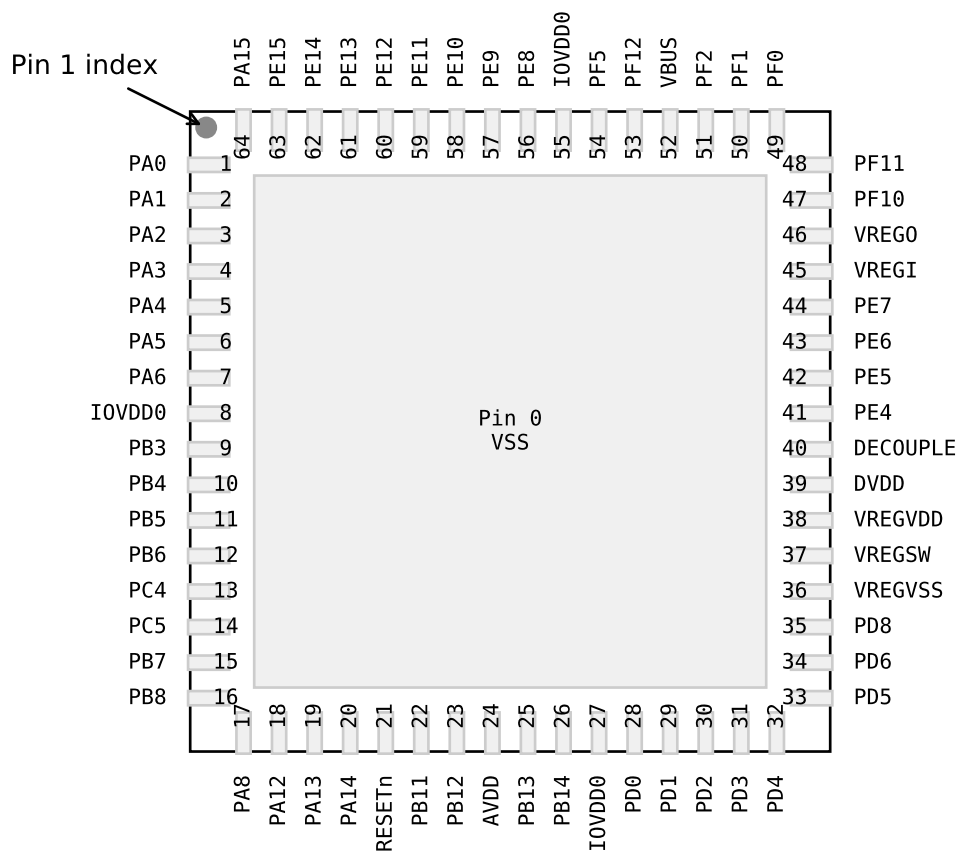


Figure 5.16. EFM32GG11B8xx in QFN64 Device Pinout

The following table provides package pin connections and general descriptions of pin functionality. For detailed information on the supported features for each GPIO pin, see [5.20 GPIO Functionality Table](#) or [5.21 Alternate Functionality Overview](#).

Table 5.16. EFM32GG11B8xx in QFN64 Device Pinout

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
VSS	0	Ground	PA0	1	GPIO
PA1	2	GPIO	PA2	3	GPIO
PA3	4	GPIO	PA4	5	GPIO
PA5	6	GPIO	PA6	7	GPIO
IOVDD0	8 27 55	Digital IO power supply 0.	PB3	9	GPIO
PB4	10	GPIO	PB5	11	GPIO

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PB6	12	GPIO	PC4	13	GPIO
PC5	14	GPIO	PB7	15	GPIO
PB8	16	GPIO	PA12	17	GPIO (5V)
PA13	18	GPIO (5V)	PA14	19	GPIO
RESETn	20	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.	PB11	21	GPIO
PB12	22	GPIO	AVDD	23 27	Analog power supply.
PB13	24	GPIO	PB14	25	GPIO
PD0	28	GPIO (5V)	PD1	29	GPIO
PD2	30	GPIO (5V)	PD3	31	GPIO
PD4	32	GPIO	PD5	33	GPIO
PD6	34	GPIO	PD7	35	GPIO
PD8	36	GPIO	PC6	37	GPIO
PC7	38	GPIO	DVDD	39	Digital power supply.
DECOUPLE	40	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.	PE4	41	GPIO
PE5	42	GPIO	PE6	43	GPIO
PE7	44	GPIO	VREGI	45	Input to 5 V regulator.
VREGO	46	Decoupling for 5 V regulator and regulator output. Power for USB PHY in USB-enabled OPNs	PF10	47	GPIO (5V)
PF11	48	GPIO (5V)	PF0	49	GPIO (5V)
PF1	50	GPIO (5V)	PF2	51	GPIO
VBUS	52	USB VBUS signal and auxiliary input to 5 V regulator.	PF12	53	GPIO
PF5	54	GPIO	PE8	56	GPIO
PE9	57	GPIO	PE10	58	GPIO
PE11	59	GPIO	PE12	60	GPIO
PE13	61	GPIO	PE14	62	GPIO
PE15	63	GPIO	PA15	64	GPIO

Note:

1. GPIO with 5V tolerance are indicated by (5V).

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PC3	12	GPIO (5V)	PC4	13	GPIO
PC5	14	GPIO	PB7	15	GPIO
PB8	16	GPIO	PA8	17	GPIO
PA9	18	GPIO	PA10	19	GPIO
RESETn	20	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.	PB11	21	GPIO
PB12	22	GPIO	AVDD	23 27	Analog power supply.
PB13	24	GPIO	PB14	25	GPIO
PD0	28	GPIO (5V)	PD1	29	GPIO
PD2	30	GPIO (5V)	PD3	31	GPIO
PD4	32	GPIO	PD5	33	GPIO
PD6	34	GPIO	PD7	35	GPIO
PD8	36	GPIO	PC6	37	GPIO
PC7	38	GPIO	DVDD	39	Digital power supply.
DECOUPLE	40	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.	PC8	41	GPIO (5V)
PC9	42	GPIO (5V)	PC10	43	GPIO (5V)
PC11	44	GPIO (5V)	PC12	45	GPIO (5V)
PC13	46	GPIO (5V)	PC14	47	GPIO (5V)
PC15	48	GPIO (5V)	PF0	49	GPIO (5V)
PF1	50	GPIO (5V)	PF2	51	GPIO
PF3	52	GPIO	PF4	53	GPIO
PF5	54	GPIO	PE8	56	GPIO
PE9	57	GPIO	PE10	58	GPIO
PE11	59	GPIO	PE12	60	GPIO
PE13	61	GPIO	PE14	62	GPIO
PE15	63	GPIO	PA15	64	GPIO

Note:

1. GPIO with 5V tolerance are indicated by (5V).

5.20 GPIO Functionality Table

A wide selection of alternate functionality is available for multiplexing to various pins. The following table shows the name of each GPIO pin, followed by the functionality available on that pin. Refer to [5.21 Alternate Functionality Overview](#) for a list of GPIO locations available for each function.

Table 5.20. GPIO Functionality Table

GPIO Name	Pin Alternate Functionality / Description				
	Analog	EBI	Timers	Communication	Other
PA15	BUSAY BUSBX LCD_SEG12	EBI_AD08 #0	TIM3_CC2 #0	ETH_MIIRXCLK #0 ETH_MDIO #3 US2_CLK #3	PRS_CH15 #0
PE15	BUSCY BUSDX LCD_SEG11	EBI_AD07 #0	TIM2_CDTI2 #2 TIM3_CC1 #0	ETH_RMIITXD0 #0 ETH_MIIRXD3 #0 SDIO_CMD #1 US0_RTS #0 QSPI0_DQS #1 LEU0_RX #2	PRS_CH14 #2 ETM_TD3 #4
PE14	BUSDY BUSCX LCD_SEG10	EBI_AD06 #0	TIM2_CDTI1 #2 TIM3_CC0 #0	ETH_RMIITXD1 #0 ETH_MIIRXD2 #0 SDIO_CLK #1 US0_CTS #0 QSPI0_SCLK #1 LEU0_TX #2	PRS_CH13 #2 ETM_TD2 #4
PE13	BUSCY BUSDX LCD_SEG9	EBI_AD05 #0	TIM1_CC3 #1 TIM2_CC2 #3 LE- TIM0_OUT1 #4	SDIO_CLK #0 ETH_MIIRXD1 #0 US0_TX #3 US0_CS #0 U1_RX #4 I2C0_SCL #6	LES_ALTEX7 PRS_CH2 #3 ACMP0_O #0 ETM_TD1 #4 GPIO_EM4WU5
PE12	BUSDY BUSCX LCD_SEG8	EBI_AD04 #0	TIM1_CC2 #1 TIM2_CC1 #3 WTIM0_CDTI2 #0 LETIM0_OUT0 #4	SDIO_CMD #0 ETH_MIIRXD0 #0 US0_RX #3 US0_CLK #0 U1_TX #4 I2C0_SDA #6	CMU_CLK1 #2 CMU_CLKI0 #6 LES_ALTEX6 PRS_CH1 #3 ETM_TD0 #4
PE11	BUSCY BUSDX LCD_SEG7	EBI_AD03 #0 EBI_CS3 #4	TIM1_CC1 #1 TIM4_CC2 #7 WTIM0_CDTI1 #0	SDIO_DAT0 #0 QSPI0_DQ7 #0 ETH_MIIRXDV #0 US0_RX #0	LES_ALTEX5 PRS_CH3 #2 ETM_TCLK #4
PE10	BUSDY BUSCX LCD_SEG6	EBI_AD02 #0 EBI_CS2 #4	TIM1_CC0 #1 TIM4_CC1 #7 WTIM0_CDTI0 #0	SDIO_DAT1 #0 QSPI0_DQ6 #0 ETH_MIIRXER #0 US0_TX #0	PRS_CH2 #2 GPIO_EM4WU9
PE9	BUSCY BUSDX LCD_SEG5	EBI_AD01 #0 EBI_CS1 #4	TIM4_CC0 #7 PCNT2_S1IN #1	SDIO_DAT2 #0 QSPI0_DQ5 #0 US5_RX #0	PRS_CH8 #2
PE8	BUSDY BUSCX LCD_SEG4	EBI_AD00 #0 EBI_CS0 #4	TIM2_CDTI0 #2 TIM4_CC2 #6 PCNT2_S0IN #1	SDIO_DAT3 #0 QSPI0_DQ4 #0 US5_TX #0 I2C2_SDA #0	PRS_CH3 #1
PI9		EBI_A14 #2	TIM1_CC3 #7 TIM4_CC1 #3	US4_CS #3	
PI6		EBI_A11 #2	TIM1_CC0 #7 TIM4_CC1 #2 WTIM3_CC0 #5	US4_TX #3	

GPIO Name	Pin Alternate Functionality / Description				
	Analog	EBI	Timers	Communication	Other
PF7	BUSCY BUSDX LCD_SEG25	EBI_BL1 #0 EBI_BL1 #4 EBI_BL1 #5 EBI_DCLK #1	TIM0_CC1 #1 TIM4_CC1 #4	ETH_RMIITXD0 #1 US2_RX #4 QSPI0_CS0 #0 ETH_MIIIRXER #2 US1_RX #3 U0_RX #0	PRS_CH23 #2
PF6	BUSDY BUSCX LCD_SEG24	EBI_BL0 #0 EBI_BL0 #4 EBI_BL0 #5 EBI_CSTFT #1	TIM0_CC0 #1 TIM4_CC0 #4 WTIM3_CC2 #5	ETH_RMIITXD1 #1 US2_TX #4 QSPI0_SCLK #0 US1_TX #3 U0_TX #0	PRS_CH22 #2
PI11				US4_RTS #3	
PI8		EBI_A13 #2	TIM1_CC2 #7 TIM4_CC0 #3	US4_CLK #3	
PF5	BUSCY BUSDX LCD_SEG3	EBI_REn #0 EBI_REn #5 EBI_A27 #1	TIM0_CDTI2 #2 TIM1_CC3 #6 TIM4_CC0 #2	US2_CS #5 I2C2_SCL #0 USB_VBUSEN	PRS_CH2 #1 DBG_TDI
PF13	BUSCY BUSDX		TIM1_CC0 #6 TIM4_CC0 #1 TIM5_CC1 #7 WTIM3_CC0 #7	US5_CLK #2 I2C2_SDA #4	
PF3	BUSCY BUSDX LCD_SEG1	EBI_ALE #0	TIM4_CC0 #0 TIM0_CDTI0 #2 TIM1_CC1 #5	CAN1_TX #1 US1_CTS #2 I2C2_SCL #5	CMU_CLK1 #4 PRS_CH0 #1 ETM_TD3 #1
PF2	BUSDY BUSCX LCD_SEG0	EBI_ARDY #0 EBI_A26 #1	TIM0_CC2 #4 TIM1_CC0 #5 TIM2_CC0 #3	US2_CLK #5 CAN0_TX #1 US1_TX #5 U0_RX #5 LEU0_TX #4 I2C1_SCL #4	CMU_CLK0 #4 PRS_CH0 #3 ACMP1_O #0 DBG_TDO DBG_SWO #0 GPIO_EM4WU4
PF1	BUSCY BUSDX	EBI_A25 #1	TIM0_CC1 #4 WTIM0_CC2 #4 LE- TIM0_OUT1 #2	US2_RX #5 CAN1_RX #1 US1_CS #2 U0_TX #5 LEU0_RX #3 I2C0_SCL #5	PRS_CH4 #2 DBG_SWDIOTMS GPIO_EM4WU3 BOOT_RX
PA1	BUSAY USBX LCD_SEG14	EBI_AD10 #0 EBI_DCLK #3	TIM0_CC0 #7 TIM0_CC1 #0 TIM3_CC1 #4 PCNT0_S1IN #4	ETH_RMIIRXD1 #0 ETH_MIITXD3 #0 SDIO_DAT1 #1 US3_RX #0 QSPI0_CS1 #1 I2C0_SCL #0	CMU_CLK1 #0 PRS_CH1 #0
PD12	LCD_SEG31	EBI_CS3 #0	TIM4_CC1 #6	ETH_RMIIRXER #1 SDIO_DAT4 #0 QSPI0_DQ3 #0 ETH_MIIIRXCLK #2 US4_CS #1	
PD14		EBI_NANDWEn #1	TIM2_CDTI1 #1 TIM3_CC2 #6 WTIM0_CC2 #1	ETH_MDC #1 CAN0_RX #5 US4_RTS #1 US5_CS #1 I2C0_SDA #3	

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
LCD_BEXT	0: PA14		LCD external supply bypass in step down or charge pump mode. If using the LCD in step-down or charge pump mode, a 1 uF (minimum) capacitor between this pin and VSS is required. To reduce supply ripple, a larger capacitor of approximately 1000 times the total LCD segment capacitance may be used. If using the LCD with the internal supply source, this pin may be left unconnected or used as a GPIO.
LCD_COM0	0: PE4		LCD driver common line number 0.
LCD_COM1	0: PE5		LCD driver common line number 1.
LCD_COM2	0: PE6		LCD driver common line number 2.
LCD_COM3	0: PE7		LCD driver common line number 3.
LCD_SEG0	0: PF2		LCD segment line 0.
LCD_SEG1	0: PF3		LCD segment line 1.
LCD_SEG2	0: PF4		LCD segment line 2.
LCD_SEG3	0: PF5		LCD segment line 3.
LCD_SEG4	0: PE8		LCD segment line 4.
LCD_SEG5	0: PE9		LCD segment line 5.
LCD_SEG6	0: PE10		LCD segment line 6.

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
LES_ALTEX6	0: PE12		LESENSE alternate excite output 6.
LES_ALTEX7	0: PE13		LESENSE alternate excite output 7.
LES_CH0	0: PC0		LESENSE channel 0.
LES_CH1	0: PC1		LESENSE channel 1.
LES_CH2	0: PC2		LESENSE channel 2.
LES_CH3	0: PC3		LESENSE channel 3.
LES_CH4	0: PC4		LESENSE channel 4.
LES_CH5	0: PC5		LESENSE channel 5.
LES_CH6	0: PC6		LESENSE channel 6.
LES_CH7	0: PC7		LESENSE channel 7.
LES_CH8	0: PC8		LESENSE channel 8.
LES_CH9	0: PC9		LESENSE channel 9.
LES_CH10	0: PC10		LESENSE channel 10.

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
US1_CTS	0: PB9 1: PD4 2: PF3 3: PC6	4: PC12 5: PB13 6: PH2	USART1 Clear To Send hardware flow control input.
US1_RTS	0: PB10 1: PD5 2: PF4 3: PC7	4: PC13 5: PB14 6: PH3	USART1 Request To Send hardware flow control output.
US1_RX	0: PC1 1: PD1 2: PD6 3: PF7	4: PC2 5: PA0 6: PA2	USART1 Asynchronous Receive. USART1 Synchronous mode Master Input / Slave Output (MISO).
US1_TX	0: PC0 1: PD0 2: PD7 3: PF6	4: PC1 5: PF2 6: PA14	USART1 Asynchronous Transmit. Also used as receive input in half duplex communication. USART1 Synchronous mode Master Output / Slave Input (MOSI).
US2_CLK	0: PC4 1: PB5 2: PA9 3: PA15	4: PF8 5: PF2	USART2 clock input / output.
US2_CS	0: PC5 1: PB6 2: PA10 3: PB11	4: PF9 5: PF5	USART2 chip select input / output.
US2_CTS	0: PC1 1: PB12 2: PA11 3: PB10	4: PC12 5: PD6	USART2 Clear To Send hardware flow control input.
US2_RTS	0: PC0 1: PB15 2: PA12 3: PC14	4: PC13 5: PD8	USART2 Request To Send hardware flow control output.
US2_RX	0: PC3 1: PB4 2: PA8 3: PA14	4: PF7 5: PF1	USART2 Asynchronous Receive. USART2 Synchronous mode Master Input / Slave Output (MISO).
US2_TX	0: PC2 1: PB3 2: PA7 3: PA13	4: PF6 5: PF0	USART2 Asynchronous Transmit. Also used as receive input in half duplex communication. USART2 Synchronous mode Master Output / Slave Input (MOSI).
US3_CLK	0: PA2 1: PD7 2: PD4 3: PG8	4: PG2 5: PI14	USART3 clock input / output.
US3_CS	0: PA3 1: PE4 2: PC14 3: PC0	4: PG3 5: PI15	USART3 chip select input / output.
US3_CTS	0: PA4 1: PE5 2: PD6 3: PG10	4: PG4 5: PG9	USART3 Clear To Send hardware flow control input.

Port	Bus	CH31	CH30	CH29	CH28	CH27	CH26	CH25	CH24	CH23	CH22	CH21	CH20	CH19	CH18	CH17	CH16	CH15	CH14	CH13	CH12	CH11	CH10	CH9	CH8	CH7	CH6	CH5	CH4	CH3	CH2	CH1	CH0	
OPA3_OUT																																		
APORT1Y	BUSAY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	
APORT2Y	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	
APORT3Y	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	
APORT4Y	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	
APORT1X	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	
APORT2X	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	
APORT3X	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	
APORT4X	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	
APORT1P	BUSAP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	
APORT2P	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	
APORT3P	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	
APORT4P	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	
VDAC0_OUT0 / OPA0_OUT																																		
APORT1Y	BUSAY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	
APORT2Y	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	
APORT3Y	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY	BUSCY
APORT4Y	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY
APORT1X	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX
APORT2X	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX
APORT3X	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX
APORT4X	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY
APORT1P	BUSAP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP
APORT2P	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP	BUSBP
APORT3P	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP	BUSCP
APORT4P	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	B			

6.2 BGA192 PCB Land Pattern

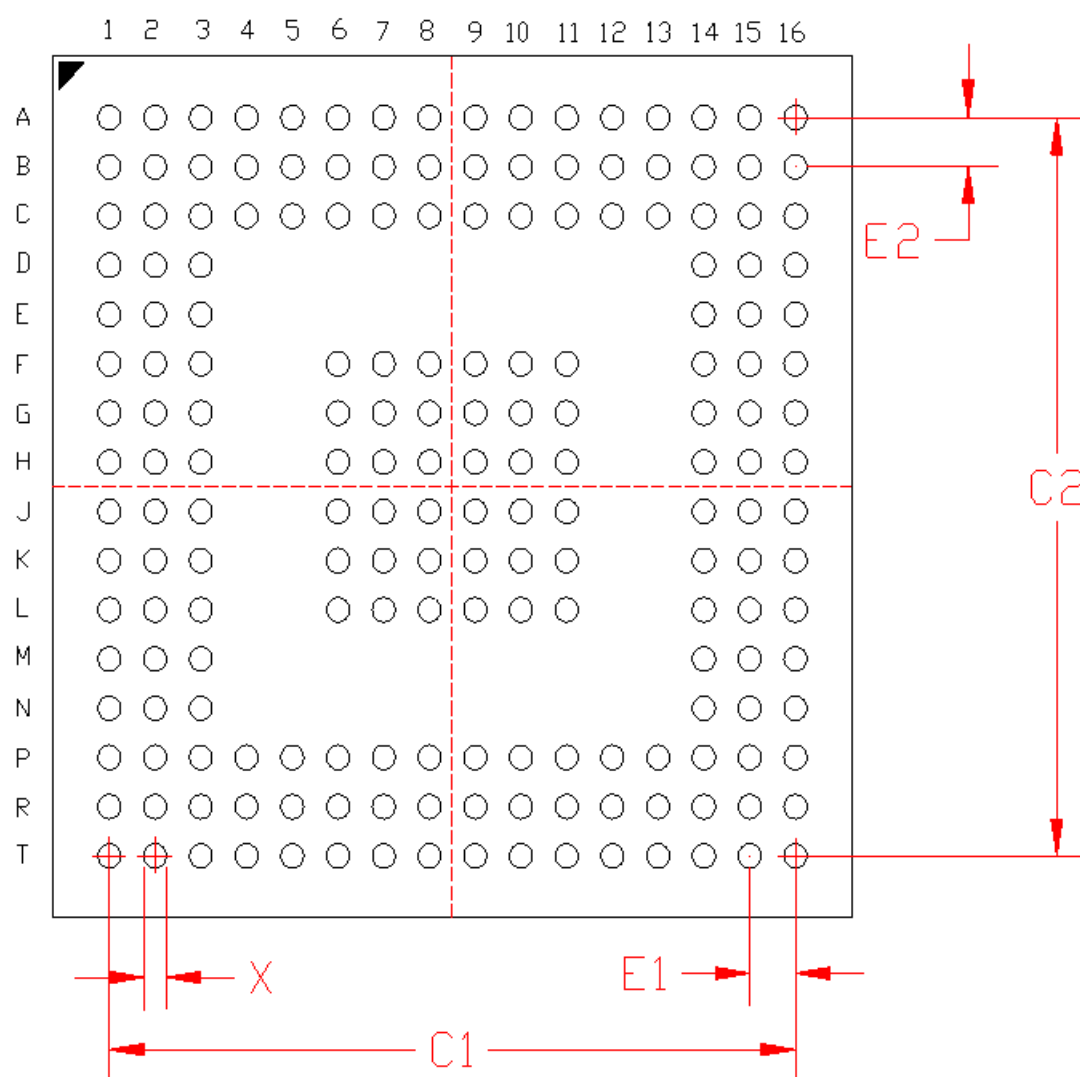


Figure 6.2. BGA192 PCB Land Pattern Drawing

Table 12.1. QFN64 Package Dimensions

Dimension	Min	Typ	Max
A	0.70	0.75	0.80
A1	0.00	—	0.05
b	0.20	0.25	0.30
A3	0.203 REF		
D	9.00 BSC		
e	0.50 BSC		
E	9.00 BSC		
D2	7.10	7.20	7.30
E2	7.10	7.20	7.30
L	0.40	0.45	0.50
L1	0.00	—	0.10
aaa	0.10		
bbb	0.10		
ccc	0.10		
ddd	0.05		
eee	0.08		

Note:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.